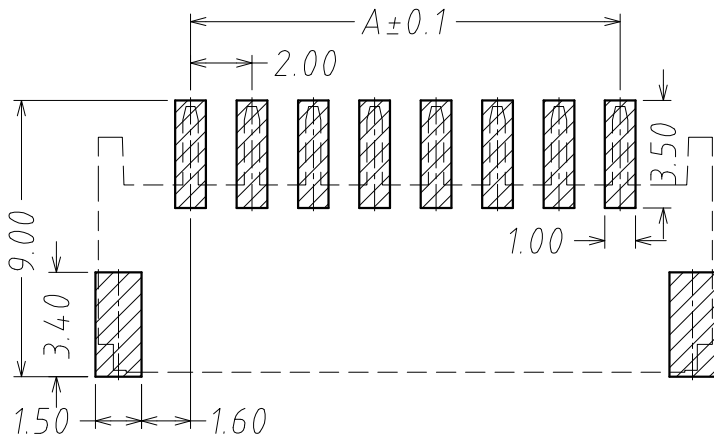
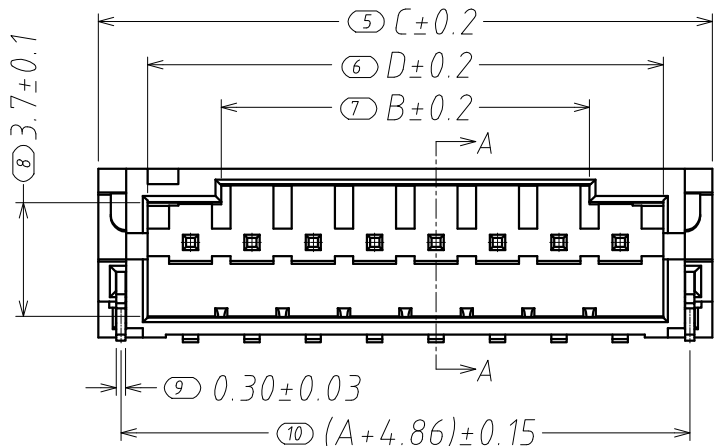
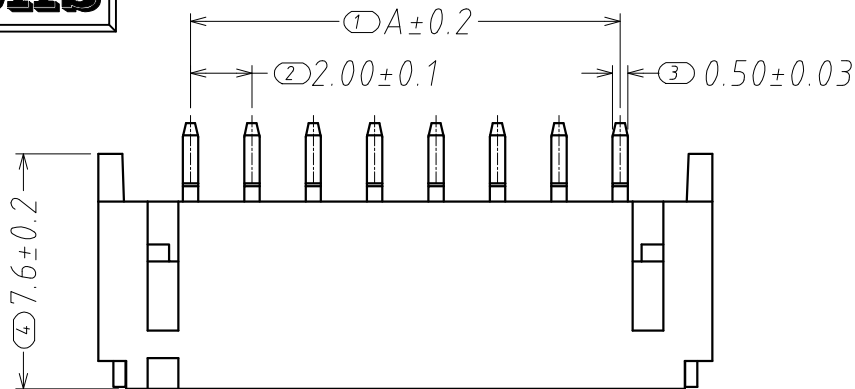
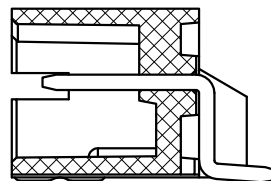
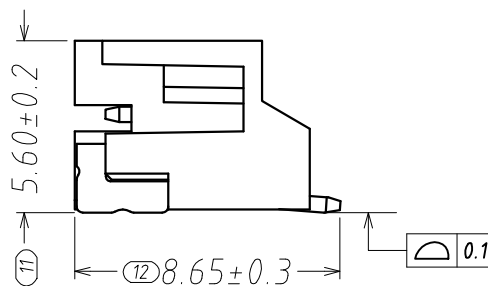
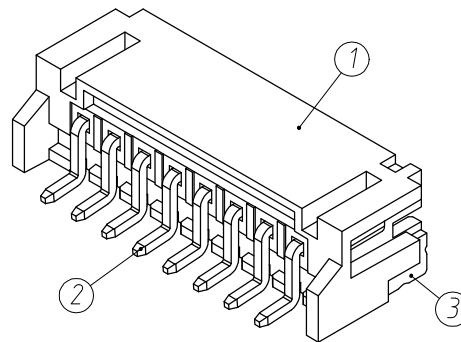


RoHS



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



SECTION A-A

技术参数:
1、所有材料符合ROHS2.0/REACH/HF要求。
2、额定电流: 2A, AC, DC;
3、额定电压: 100V, AC, DC;
4、温度范围: $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$;
5、接触电阻: $\leq 0.02 \Omega$;
6、绝缘电阻: $\geq 1000 \text{M}\Omega$;
7、耐压: 800V, AC/minute.
8、产品料号:
A10001 - n AWB - 03 T1
孔位 — 电镀
产品类型 — T1: 镀亮锡
AWB: 贴片针座 — 胶芯材质
03: LCP 本色

Circuits	Dimensions (mm)			
	A	B	C	D
02	2.00	1.00	8.00	4.80
03	4.00	2.00	10.00	6.80
04	6.00	4.00	12.00	8.80
05	8.00	6.00	14.00	10.80
06	10.00	8.00	16.00	12.80
07	12.00	10.00	18.00	14.80
08	14.00	12.00	20.00	16.80
09	16.00	14.00	22.00	18.80
10	18.00	16.00	24.00	20.80
11	20.00	18.00	26.00	22.80
12	22.00	20.00	28.00	24.80
13	24.00	22.00	30.00	26.80
...	...	...	...	...
20	38.00	36.00	44.00	40.80

3	焊片 Fitting Nail	黄铜 Brass	2	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u" MIN.
2	端子 Contact	黄铜 Brass	n*1	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u" MIN.
1	基座 Wafer	LCP (UL94V-0)	1	本色
序号	名称	材料	数量	附注

DESIGN:		Xiping Huang			广东国连电子有限公司						
CHECK:		Ke Tian			GUANGDONG GUOLIAN ELECTRONICS CO.,LTD						
APPROVED:		Youquan Xu			TITLE:						
DIM		TOL	DIM		TOL			PH2.0贴片			
X.		±0.25			PART NO.		A20001-nAWB-03T1				
X.X		±0.20	X°								
X.XX		±0.15	X.X°								
X.XXX			X.XX°								
			X.XXX°		REV. A		SCALE:	N/A	UNIT:	SHEET:	
									mm	1/1	